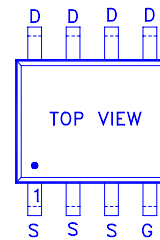
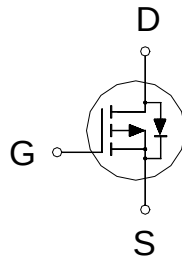


PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
-30	20m Ω	-9A



4 :GATE
5,6,7,8 :DRAIN
1,2,3 :SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_C = 25\text{ }^\circ\text{C}$	I_D	-9	A
	$T_C = 70\text{ }^\circ\text{C}$		-8	
Pulsed Drain Current ¹		I_{DM}	-50	
Power Dissipation	$T_C = 25\text{ }^\circ\text{C}$	P_D	2.5	W
	$T_C = 70\text{ }^\circ\text{C}$		1.3	
Operating Junction & Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		25	$^\circ\text{C} / \text{W}$
Junction-to-Ambient	$R_{\theta JA}$		50	$^\circ\text{C} / \text{W}$

¹Pulse width limited by maximum junction temperature.

²Duty cycle $\leq 1\%$

ELECTRICAL CHARACTERISTICS ($T_C = 25\text{ }^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1	-1.5	-3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24V, V_{GS} = 0V$			-1	μA
		$V_{DS} = -20V, V_{GS} = 0V, T_J = 125\text{ }^{\circ}C$			-10	
On-State Drain Current ¹	$I_{D(ON)}$	$V_{DS} = -5V, V_{GS} = -10V$	-50			A
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = -4.5V, I_D = -7A$		25	35	m Ω
		$V_{GS} = -10V, I_D = -9A$		15	20	
Forward Transconductance ¹	g_{fs}	$V_{DS} = -10V, I_D = -9A$		24		S

DYNAMIC						
Input Capacitance	C _{iSS}	V _{GS} = 0V, V _{DS} = -15V, f = 1MHz		1610		pF
Output Capacitance	C _{oSS}			410		
Reverse Transfer Capacitance	C _{rSS}			200		
Total Gate Charge ²	Q _g	V _{DS} = 0.5V _{(BR)DSS} , V _{GS} = -10V, I _D = -9A		17	24	nC
Gate-Source Charge ²	Q _{gs}			5		
Gate-Drain Charge ²	Q _{gd}			6		
Turn-On Delay Time ²	t _{d(on)}	V _{DS} = -15V, R _L = 1Ω I _D ≅ -1A, V _{GS} = -10V, R _{GS} = 6Ω		5.7		nS
Rise Time ²	t _r			10		
Turn-Off Delay Time ²	t _{d(off)}			18		
Fall Time ²	t _f			5		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T _C = 25 °C)						
Continuous Current	I _S				-2.1	A
Pulsed Current ³	I _{SM}				-4	
Forward Voltage ¹	V _{SD}	I _F = -1A, V _{GS} = 0V			-1.2	V

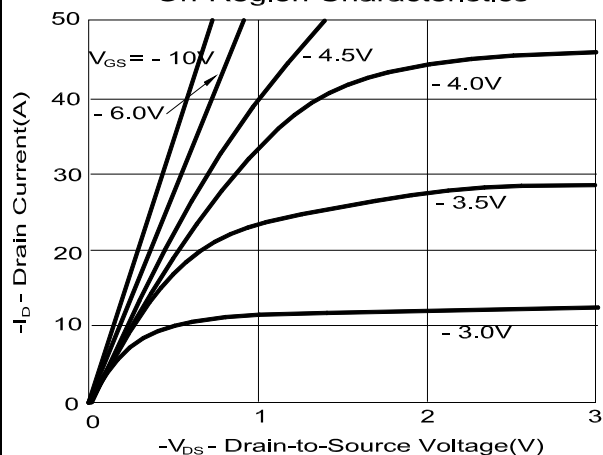
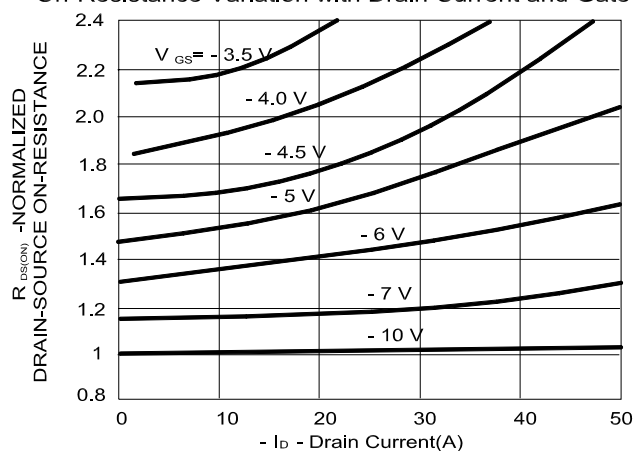
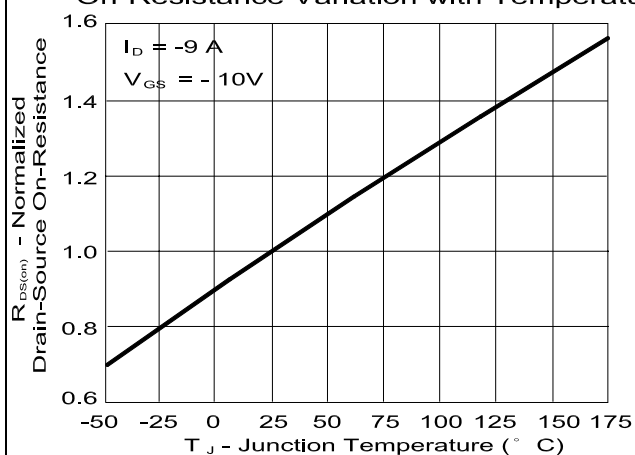
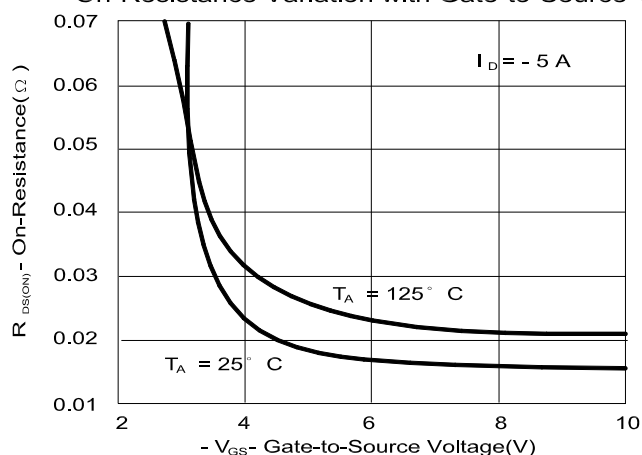
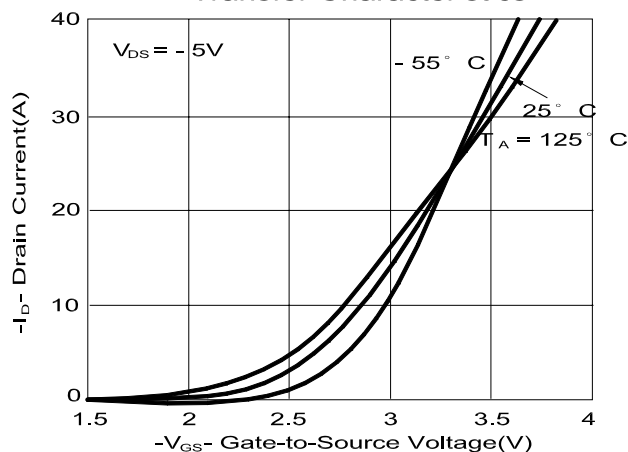
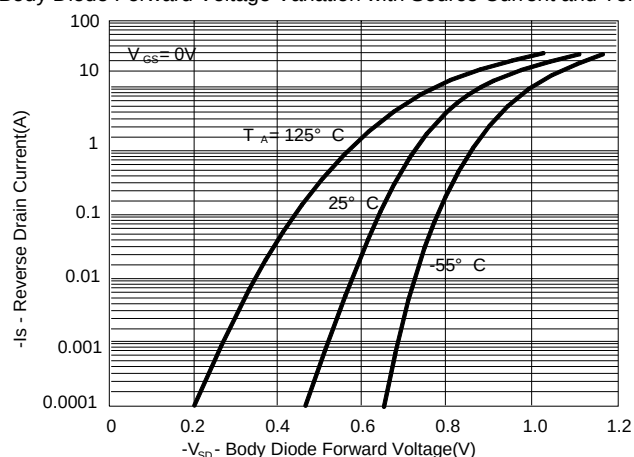
¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

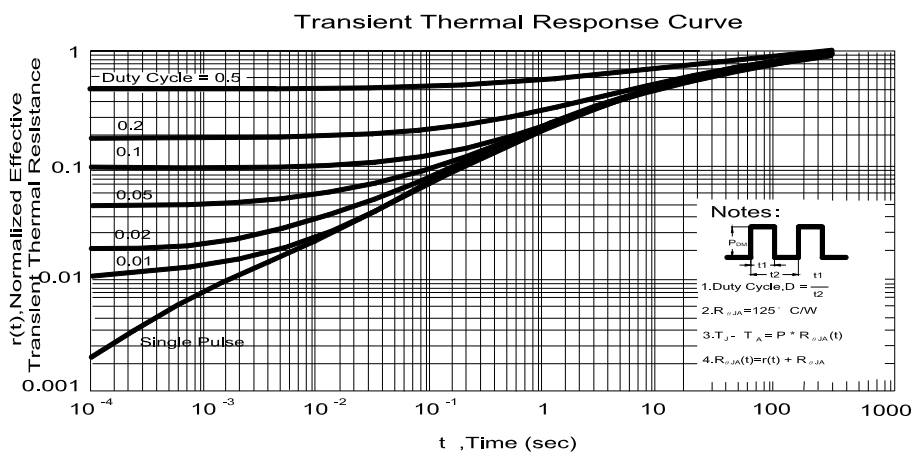
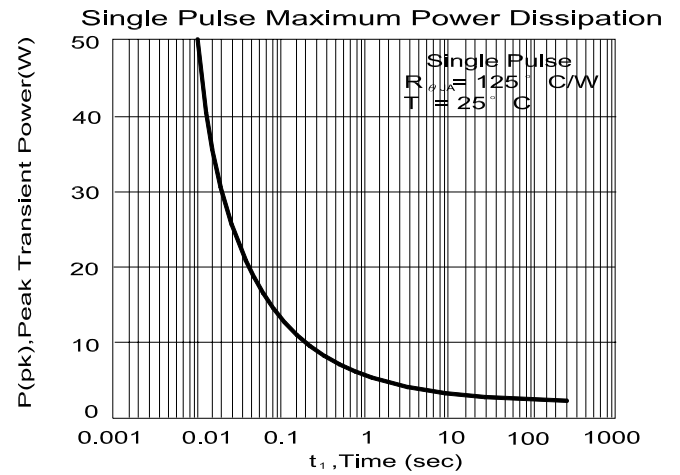
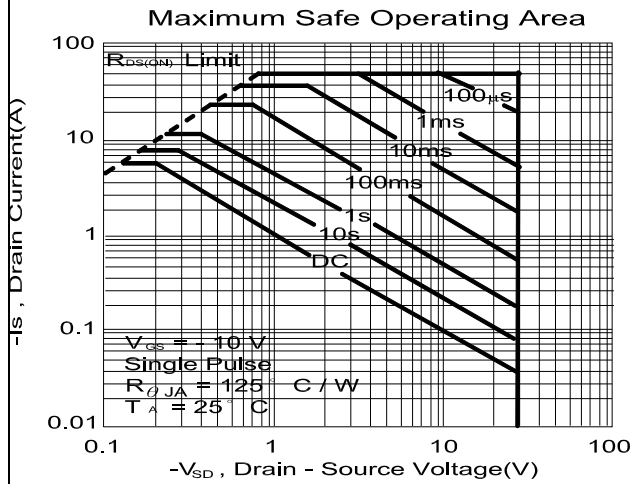
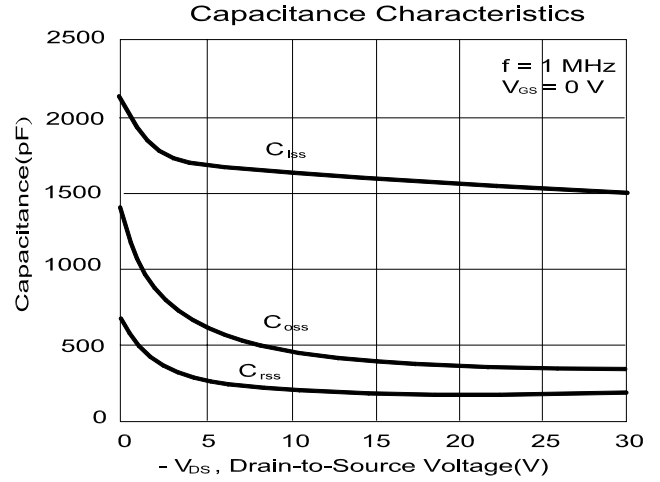
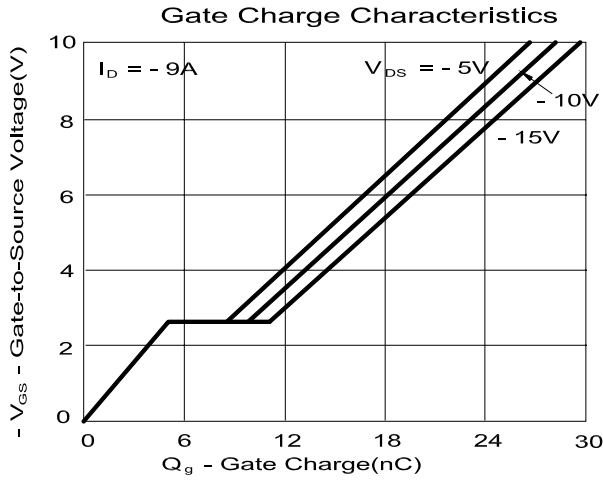
²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

REMARK: THE PRODUCT MARKED WITH "P2003EVG", DATE CODE or LOT #

Orders for parts with Lead-Free plating can be placed using the PXXXXXXG parts name.

On-Region Characteristics

On-Resistance Variation with Drain Current and Gate Voltage

On-Resistance Variation with Temperature

On-Resistance Variation with Gate-to-Source Voltage

Transfer Characteristics

Body Diode Forward Voltage Variation with Source Current and Temperature




SOIC-8(D) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8	4.9	5.0	H	0.5	0.715	0.83
B	3.8	3.9	4.0	I	0.18	0.254	0.25
C	5.8	6.0	6.2	J		0.22	
D	0.38	0.445	0.51	K	0°	4°	8°
E		1.27		L			
F	1.35	1.55	1.75	M			
G	0.1	0.175	0.25	N			

